

DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

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the specification of which: (check one)

[ ] is attached hereto. [XX] was filed on April 28, 1999, as United States Patent Application Serial No. or PCT International Application Number PCT/IP99/02273, and was amended on 19 (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with 37 CFR § 1.56(a).

Prior Foreign Application(s): I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate listed below, or § 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

(Application No.)	(Country)	(Day/Month/Year Filed)	Priority Claimed
10/119291	Japan	28/04/98	[xx] [ ]
(Application No.)	(Country)	(Day/Month/Year Filed)	Yes No
10/147809	Japan	28/05/98	[xx] [ ]
(Application No.)	(Country)	(Day/Month/Year Filed)	Yes No
10/151571	Japan	01/06/98	[xx] [ ]
(Application No.)	(Country)	(Day/Month/Year Filed)	Yes No
10/207328	Japan	23/07/98	[xx] [ ]
(Application No.)	(Country)	(Day/Month/Year Filed)	Yes No
10/207329	Japan	23/07/98	[xx] [ ]
(Application No.)	(Country)	(Day/Month/Year Filed)	Yes No
10/234428	Japan	20/08/98	[xx] [ ]
(Application No.)	(Country)	(Day/Month/Year Filed)	Yes No
10/306233	Japan	28/10/98	[xx] [ ]
(Application No.)	(Country)	(Day/Month/Year Filed)	Yes No

I hereby claim the benefit under Title 35, United States Code § 119(e) of any United States provisional application(s) listed below:

Application No.

Filing Date

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by 35 U.S.C. § 112, first paragraph, I acknowledge the duty to disclose material information as defined in 37 CFR § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(U.S. Application Serial No.)

(U.S. Filing Date)

(Status--patented, pending, abandoned)

I hereby appoint George Vande Sande, Registration No. 17,276; Burton A. Amernick, Registration No. 24,852; Richard Wiener, Registration No. 18,741; Townsend M. Belser, Jr., Registration No. 22,956; Morris Liss, Registration No. 24,510; Martin Abramson, Registration No. 25,787; George R. Pettit, Registration No. 27,369; Elzbieta Chlopecka, Registration No. 32,767; Eric J. Franklin, Registration No. 37,134; Jeffri A. Kaminski, Reg. No. 42,709; and William E. Curry, Registration No. 43,572, my attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

Send Correspondence and Direct Telephone Calls to:

Burton A. Amernick  
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Burton A. Amernick  
Pollock, Vande Sande & Amernick, R.L.L.P.  
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor: Yoshiki Nakagawa

Inventor's Signature

Date

JAN. 27. 2000

Residence Address c/o Kobe Research Laboratories Research Institute of Kaneka Corporation, 2-80, Yoshidacho 1-chome, Hyogo-ku, Kobe-shi, Hyogo 652-0872 Japan JPX

Citizenship Japan

Post Office Address Same as residence

## DECLARATION FOR PATENT APPLICATION

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Full name of second joint inventor (if any): Masayuki FujitaInventor's Signature Masayuki Fujita Date JAN. 27.2000Residence Address c/o Kobe Research Laboratories Research Institute of Kaneka Corporation, 2-80, Yoshidacho 1-chome, Hyogo-ku, Kobe-shi, Hyogo 652-0872 Japan JPXCitizenship JapanPost Office Address Same as residenceFull name of third joint inventor (if any): Kenichi KitanoInventor's Signature Kenichi Kitano Date JAN. 27.2000Residence Address c/o Kobe Research Laboratories Research Institute of Kaneka Corporation, 2-80, Yoshidacho 1-chome, Hyogo-ku, Kobe-shi, Hyogo 652-0872 Japan JPXCitizenship JapanPost Office Address Same as residenceFull name of fourth joint inventor (if any): Tomoki HiiroInventor's Signature Tomoki Hiiro Date JAN. 27.2000Residence Address c/o Kobe Research Laboratories Research Institute of Kaneka Corporation, 2-80, Yoshidacho 1-chome, Hyogo-ku, Kobe-shi, Hyogo 652-0872 Japan JPXCitizenship JapanPost Office Address Same as residenceFull name of fifth joint inventor (if any): Katsuhiko KimuraInventor's Signature Katsuhiko Kimura Date JAN. 27.2000Residence Address c/o Kobe Research Laboratories Research Institute of Kaneka Corporation, 2-80, Yoshidacho 1-chome, Hyogo-ku, Kobe-shi, Hyogo 652-0872 JapanCitizenship JapanPost Office Address Same as residence

Full name of sixth joint inventor (if any):

Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_

Residence Address \_\_\_\_\_

Citizenship \_\_\_\_\_

Post Office Address \_\_\_\_\_

Full name of seventh joint inventor (if any):

Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_

Residence Address \_\_\_\_\_

Citizenship \_\_\_\_\_

Post Office Address \_\_\_\_\_